

FORM PTO-1595

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<p>1. Name of conveying party(ies): Dietmar Gogl</p> <p>Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>	<p>2. Name and address of receiving party(ies)</p> <p>Name: Infineon Technologies North America Corp.</p> <p>Internal Address:</p> <p>Street Address:</p> <p>City: San Jose State: CA ZIP: 95112</p> <p>Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
<p>3. Nature of conveyance:</p> <p><input type="checkbox"/> Assignment <input type="checkbox"/> Merger</p> <p><input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name</p> <p><input checked="" type="checkbox"/> Other <u>Correction of Recorded Assignment</u></p> <p>Execution Date(s): July 11, 2003</p>	

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s) B. Patent No.(s)

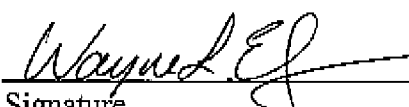
10/318,709

Additional numbers attached? Yes No

<p>5. Name and address of party to whom correspondence concerning document should be mailed:</p> <p>Name: Wayne L. Ellenbogen</p> <p>Internal Address: Ryan, Mason & Lewis, LLP</p> <p>Street Address: 90 Forest Avenue</p> <p>City: Locust Valley State: NY ZIP: 11560</p>	<p>6. Total number of applications and patents involved: <u>1</u></p> <p>7. Total Fee (37 CFR 3.41)..... \$ <u>40.00</u></p> <p><input type="checkbox"/> Enclosed</p> <p><input checked="" type="checkbox"/> Authorized to be charged to deposit account</p> <p>8. Deposit account number 50-0510</p>
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9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Wayne L. Ellenbogen  April 1, 2004

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CH \$40.00 600610 10318703

YOR920020295US1

700075768

PATENT
REEL: 014482 FRAME: 0312

IBM Docket No. YOR920020792US1

ASSIGNMENT

WHEREAS, I

(1) **Dietmar Gogl** of Essex Junction
County of Chittenden State of Vermont

have invented certain improvements in

ARCHITECTURE FOR HIGH-SPEED MAGNETIC MEMORIES

and executed a United States patent application therefor on:
(date that inventor signed the declaration)

(1) February 28, 2003

04.01.04 *Dietmar Gogl*
Delaware D.G.

Whereas, INFINEON TECHNOLOGIES NORTH AMERICA CORP, a corporation of San Jose, California, having a place of business at San Jose, CA 95112, (hereinafter called Infineon), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign and transfer to Infineon, its successors and assigns, the entire right, title and interest in the said application and the invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to Infineon, its successors and assigns; and I hereby agree that Infineon may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by Infineon.

Signed (Date Signing Assignment)

(1) at Essex Junction, VT
on 07/11/2003,

Dietmar Gogl
Dietmar Gogl